

PCN Number:	20200210000	PCN Date:	Mar. 16, 2020
Title:	Datasheet for CDCI6214		
Customer Contact:	PCN Manager	Dept:	Quality Services
Change Type:			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



CDCI6214

SNAS734E – JULY 2017 – REVISED JANUARY 2020

Changes from Revision D (June 2019) to Revision E

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• Removed fractional output divider (FOD) and spread spectrum clocking (SSC) information from the data sheet.....	1
• Added footnote to <i>Timing Characteristics</i> table	10
• Removed FOD from <i>Functional Block Diagram</i>	17
• Changed REFSEL selection from L to H.....	19
• Removed <i>Output Channel Divider Types and Delay</i> table	21
• Removed the FOD control bits in the <i>Power Management</i> graphic.....	26
• Added Page-mode EEPROM read instructions.....	29
• Changed <i>Pre-Configured EEPROM Page 0</i> graphic.....	34
• Changed <i>Pre-Configured EEPROM Page 1</i> graphic.....	35
• Removed fractional output divider information from the registers	36
• Removed FOD information from the <i>CDCI6214 Registers</i> table.....	36
• Added additional details on pullup resistor and load capacitor added to power-up sequence	91

The datasheet number will be changing.

Device Family	Change From:	Change To:
CDCI6214	SNAS734D	SNAS734E

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/CDCI6214>

Reason for Change:

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

Changes to product identification resulting from this PCN:

None.

Product Affected:

CDCI6214RGER	CDCI6214RGET		
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For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

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